

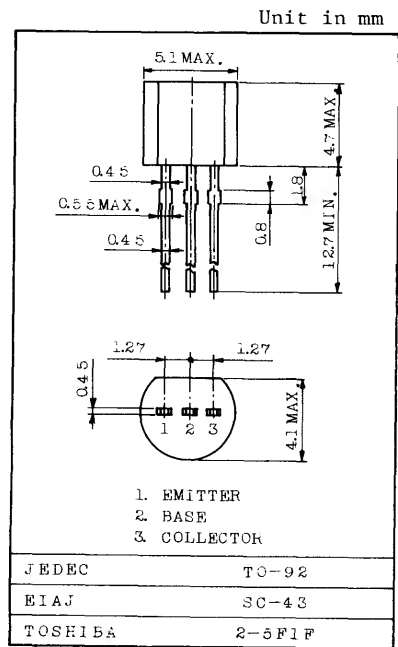
# SILICON NPN EPITAXIAL TYPE (PCT PROCESS)

# 2N4124

FOR GENERAL PURPOSE USE SWITCHING AND AMPLIFIER APPLICATIONS.

### FEATURES:

- . Low Leakage Current
  - :  $I_{CBO}=50\text{nA}(\text{Max.}) @ V_{CB}=20\text{V}$
  - :  $I_{EBO}=50\text{nA}(\text{Max.}) @ V_{EB}=3\text{V}$
- . Low Saturation Voltage
  - :  $V_{CE}(\text{sat})=0.3\text{V}(\text{Max.}) @ I_C=50\text{mA}, I_B=5\text{mA}$
- . Low Collector Output Capacitance
  - :  $C_{ob}=4\text{pF}(\text{Max.}) @ V_{CB}=5\text{V}$
- . Complementary to 2N4126



Weight : 0.21g

### MAXIMUM RATINGS ( $T_a=25^\circ\text{C}$ )

CHARACTERISTIC	SYMBOL	RATING	UNIT
* Collector-Base Voltage	$V_{CBO}$	30	V
* Collector-Emitter Voltage	$V_{CEO}$	25	V
* Emitter-Base Voltage	$V_{EBO}$	5	V
* Collector Current	$I_C$	200	mA
Base Current	$I_B$	50	mA
* Collector Power Dissipation ( $T_a=25^\circ\text{C}$ ) Derate Linearly $25^\circ\text{C}$	$P_C$	350	mW
		2.8	mW/ $^\circ\text{C}$
* Collector Power Dissipation ( $T_c=25^\circ\text{C}$ ) Derate Linearly $25^\circ\text{C}$	$P_C$	1.0	W
		8	mW/ $^\circ\text{C}$
* Thermal Resistance (Junction to Ambient)	$R_{th(j-a)}$	357	$^\circ\text{C/W}$
* Thermal Resistance (Junction to Case)	$R_{th(j-c)}$	125	$^\circ\text{C/W}$
* Junction Temperature	$T_j$	150	$^\circ\text{C}$
* Storage Temperature Range	$T_{stg}$	-55 ~ 150	$^\circ\text{C}$

\*In accordance with JEDEC registration data.

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ELECTRICAL CHARACTERISTICS (Ta=25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
* Collector Cut-off Current	ICBO	V <sub>CB</sub> =20V, I <sub>E</sub> =0	-	-	50	nA
* Emitter Cut-off Current	IEBO	V <sub>EB</sub> =3V, I <sub>C</sub> =0	-	-	50	nA
* Collector-Base Breakdown Voltage	V(BR)CBO	I <sub>C</sub> =10μA, I <sub>E</sub> =0	30	-	-	V
* Collector-Emitter Breakdown Voltage	V(BR)CEO	I <sub>C</sub> =1mA, I <sub>B</sub> =0	25	-	-	V
* Emitter-Base Breakdown Voltage	V(BR)EBO	I <sub>E</sub> =10μA, I <sub>C</sub> =0	5	-	-	V
* DC Current Gain	h <sub>FE</sub> (1)	V <sub>CE</sub> =1V, I <sub>C</sub> =2mA	120	-	360	
	h <sub>FE</sub> (2)	V <sub>CE</sub> =1V, I <sub>C</sub> =50mA	60	-	-	
* Collector-Emitter Saturation Voltage	V <sub>CE(sat)</sub>	I <sub>C</sub> =50mA, I <sub>B</sub> =5mA	-	-	0.3	V
* Base-Emitter Saturation Voltage	V <sub>BE(sat)</sub>	I <sub>C</sub> =50mA, I <sub>B</sub> =5mA	-	-	0.95	V
* Small Signal Forward Current Transfer Ratio	h <sub>fe</sub>	V <sub>CE</sub> =20V, I <sub>C</sub> =10mA, f=100MHz	3.0	-	-	
* Transition Frequency	f <sub>T</sub>	V <sub>CE</sub> =20V, I <sub>C</sub> =10mA, f=100MHz	300	-	-	MHz
* Collector Output Capacitance	C <sub>ob</sub>	V <sub>CB</sub> =5V, I <sub>E</sub> =0, f=1MHz	-	-	4	pF
* Input Capacitance	C <sub>ib</sub>	V <sub>EB</sub> =0.5V, I <sub>C</sub> =0, f=1MHz	-	-	8	pF
* Small Signal Current Gain	h <sub>fe</sub>	V <sub>CE</sub> =10V, I <sub>C</sub> =2mA, f=1kHz	120	-	480	
* Noise Figure	NF	V <sub>CE</sub> =5V, I <sub>C</sub> =100μA R <sub>g</sub> =1kΩ, f=10Hz ~ 15.7kHz	-	-	5	dB

\* In accordance with JEDEC registration data.